

Electronic Acknowledgement Receipt

EFS ID:	9150505
Application Number:	10715267
International Application Number:	
Confirmation Number:	4590
Title of Invention:	METHODS FOR POLISHING SEMICONDUCTOR DEVICE STRUCTURES BY DIFFERENTIALLY APPLYING PRESSURE TO SUBSTRATES THAT CARRY THE SEMICONDUCTOR DEVICE STRUCTURES
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/Message Digest	Multi Part/.zip	Pages (if appl.)
1	Request for Continued Examination (RCE)	ROUND581_-_Request_for_Continued_Examination_Fillable_PDF.pdf	790975 8d4d96a170ee723f7d5b079f7537eb157ed370b	no	3
Warnings:					
Information:					
2	Miscellaneous Incoming Letter	Certificate_of_RCE.pdf	13189 3bb09cd706ca7b19ffec1ad1a032e06d1efc4f792	no	1
Warnings:					
Information:					
3	Information Disclosure Statement (IDS) Filed (SB/08)	ROUND581_-_Information_Disclosure_Statement_Fillable_PDF.pdf	612109 f3a2c36757bf65466d8163722ac972d1cb15b9f	no	4
Warnings:					
Information:					
4	Transmittal Letter	ROUND581_-_IDS_-_Information_Disclosure_Statement_-_Reference_Enclosed_LD-458.pdf	24956 9d7c158ba7d049852b78dd0b5c5e7e0d8cfa5e2a	no	2
Warnings:					
Information:					
5	NPL Documents	ROUND582_-_Mechanical.pdf	494726 32b1f55b90e657c24616c3ac0b215013e8c6eff	no	7
Warnings:					
Information:					
6	NPL Documents	ROUND582_-_Websters1.pdf	315619 54d802e0ffab4b152130dc7a515a7295092c240	no	3
Warnings:					
Information:					
7	NPL Documents	ROUND582_-_Websters2.pdf	327856 a1f733e6100d8191bd1a2949b0209a152c23d1	no	3
Warnings:					
Information:					
8	Fee Worksheet (PTO-875)	fee-info.pdf	30725 4bca41e3432185f7cd895c172d0f9079b92	no	2
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National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

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